

Technical Data Sheet Rev 1.

Conductive PLA

Electrify prints for Simple Circuits & Touch-Sensitive Devices.

Now with improved layer adhesion, increased resilience to break, higher melt flow, and, in general, greater consistency for more trouble-free, higher performance printing experience.

- Great for simple circuitry and interactive projects
- Also experiment with ESD or 3D printed bearings!

How Conductive Is It?

- Volume resistivity of molded resin (not 3D Printed): 15 ohm-cm
- Volume resistivity of 3D printed parts along layers (x/y): 30 ohm-cm
- Volume resistivity of 3D printed parts against layers (z): 115 ohm-cm
- Resistance of a 10cm length of 1.75mm filament: 2-3kohm
- Resistance of a 10cm length of 2.85mm filament: 800-1200ohm

Material Properties

| Properties | Value/Description | |
|-----------------------------|---|--|
| Base material | PLA | |
| Characteristics | low odor, non-toxic, renewably sourced | |
| Molecular structure | Amorphous | |
| Additives | Carbon black / Polymer | |
| Max particle size | N/A | |
| Density | approx. 1.24 g/cc | |
| Length | Approx. 332 m/kg (1.75 mm) & 124 m/kg (2.85 mm) | |
| Min bend diameter | mm 25 (1.75 mm) & mm 50 (2.85 mm) | |
| Glass transition (Tg) onset | N/A | |
| Melt point (Tm) onset | approx. 155 deg C (310 deg F) | |
| Max use | N/A | |

Use limit is geometry, load & condition dependent

Print Settings

(Based on Ultimaker s5 .15mm Profile)

| Setting | Value |
|------------------------------------|-------------------------------------|
| Nozzle Temperature [°C] | 215 |
| Heated Bed Temperature [°C] | 60 |
| Print Speed [mm/s] | 25-45 |
| Flow Rate/Extrusion Multiplier [%] | 100 |
| Extrusion Width [mm] | .45 (.05mm larger than nozzle size) |
| Volume Flow Rate [mm³/s] | 2-3 |

Results may vary based on print settings as well as print quality

For more information please view proto-pasta.com/conductive